### **STD1NK60-1**



# N-channel 600 V, 7.3 Ω typ., 1 A SuperMESH™ Power MOSFET in an IPAK package

Datasheet - production data

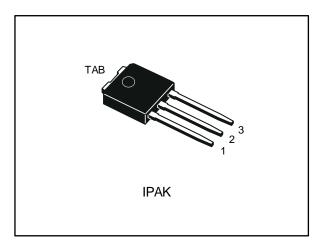
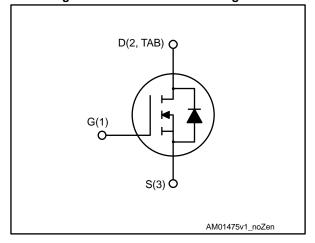


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD	Ртот
STD1NK60-1	600 V	8.5 Ω	1 A	30 W

- Extremely high dv/dt capability
- ESD improved capability
- 100% avalanche tested
- Gate charge minimized

### **Applications**

- Low power battery chargers
- Swith mode low power supplies (SMPS)
- Low power, ballast, CFL (compact fluorescent lamps)

### **Description**

This high voltage device is an N-channel Power MOSFET developed using the SuperMESH™ technology by STMicroelectronics, an optimization of the well-established PowerMESH™. In addition to a significant reduction in on-resistance, this device is designed to ensure a high level of dv/dt capability for the most demanding applications.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STD1NK60-1	D1NK60	IPAK	Tube

Contents STD1NK60-1

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STD1NK60-1 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	600	V
$V_{DGR}$	Drain-gate voltage ( $R_{GS}$ = 20 k $\Omega$ )	600	V
V <sub>G</sub> s	Gate-source voltage	±30	V
ΙD	Drain current (continuous) at T <sub>C</sub> = 25 °C	1.0	Α
$I_D$	Drain current (continuous) at T <sub>C</sub> = 100 °C	0.63	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	4	Α
Ртот	Total dissipation at $T_C = 25$ °C	30	W
I <sub>AR</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_{jmax}$ )	1	Α
Eas	Single pulse avalanche energy (starting $T_j$ = 25 °C, $I_D$ = $I_{AR}$ , $V_{DD}$ = 50 V)	25	mJ
dv/dt (2)	Peak diode recovery voltage slope	3	V/ns
Tj	Operating junction temperature range	55 to 150	°C
T <sub>stg</sub>	Storage temperature range	- 55 to 150	C

### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	4.2	°C/W
R <sub>thj-amb</sub>	R <sub>thj-amb</sub> Thermal resistance junction-ambient		°C/W

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area.

 $<sup>^{(2)}</sup>I_{SD} \leq 1.0$  A, di/dt  $\leq 100$  A/µs; V<sub>DD</sub>  $\leq V_{(BR)DSS},$  T<sub>J</sub>  $\leq T_{JMAX}$ 

Electrical characteristics STD1NK60-1

### 2 Electrical characteristics

 $T_C = 25$  ° C unless otherwise specified

Table 4: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	600			V
	7	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V			1	μΑ
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$ $T_{C} = 125 ^{\circ}\text{C}$ (1)			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	V <sub>DS</sub> =0 V, V <sub>GS</sub> = ±30 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.25	3	3.7	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A		7.3	8.5	Ω

#### Notes:

**Table 5: Dynamic** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	156	ı	pF
Coss	Output capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	23.5	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	VDS = 23 V, I = 1 IVII 12, VGS = 0 V		3.8	-	pF
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 1 A	-	7	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	1.1	ı	nC
$Q_{gd}$	Gate-drain charge	(see Figure 16: "Test circuit for gate charge behavior")	-	3.7	-	nC

**Table 6: Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 300 V, $I_{D}$ = 0.5 A, $R_{G}$ = 4.7 $\Omega$	-	6.5	-	ns
tr	Rise time	V <sub>GS</sub> = 10 V	-	5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 15: "Test circuit for resistive load switching times" and	-	19	-	ns
t <sub>f</sub>	Fall time	Figure 20: "Switching time waveform")	-	25	1	ns

 $<sup>\</sup>ensuremath{^{(1)}}\mbox{Defined}$  by design, not subject to production test.

Table 7: Source-drain diode

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		1	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		4	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 1.0 A, V <sub>GS</sub> = 0 V	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 1.0 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	140		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 25 V (see Figure 17: "Test circuit for	-	240		nC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	3.3		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 1.0 A, di/dt = 100 A/µs,	-	229		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 25 V, T <sub>j</sub> = 150 °C (see Figure 17: "Test circuit for	-	377		nC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	3.3		Α

#### Notes:

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}\</sup>text{Pulsed:}$  pulse duration = 300  $\mu$  s, duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

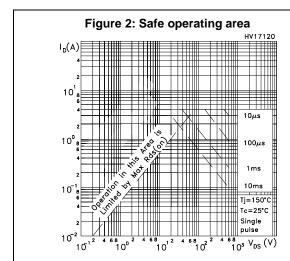
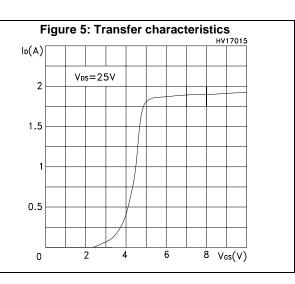
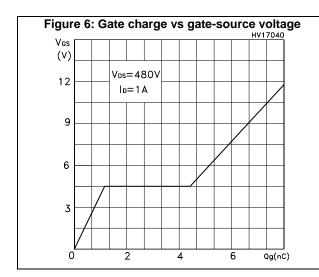
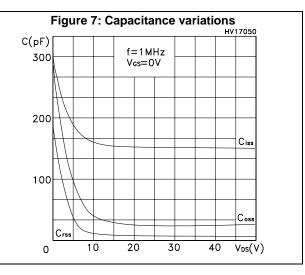


Figure 3: Thermal impedance

K  $00^{-1}$   $0^{-1}$   $0^{-1}$   $0^{-2}$  0







STD1NK60-1 Electrical characteristics

Figure 8: Static drain-source on-resistance

R<sub>DS(on)</sub> (Ω)

8.5

V<sub>GS</sub>=10V

8

7.5

7

6.5

0

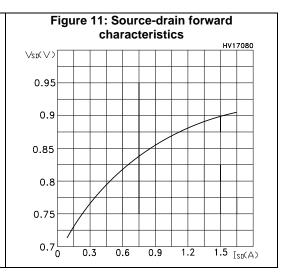
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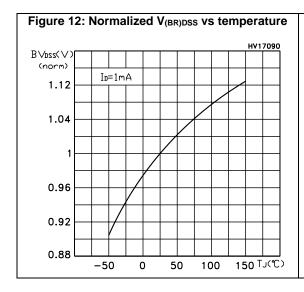
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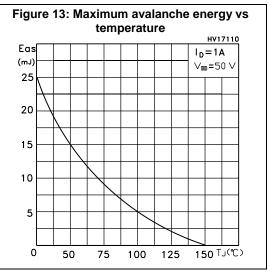
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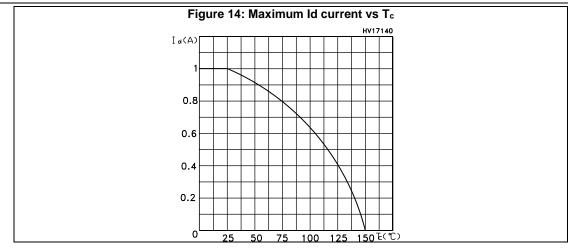
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I<sub>D</sub>(A)



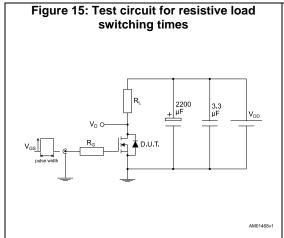






STD1NK60-1 Test circuits

### 3 Test circuits



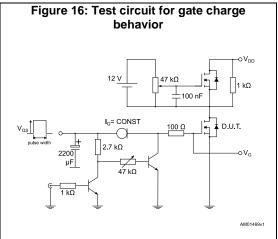
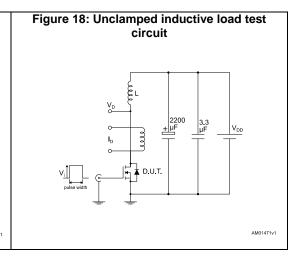
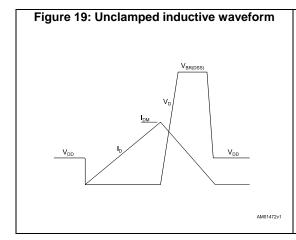
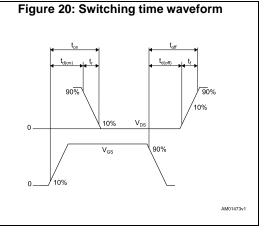


Figure 17: Test circuit for inductive load switching and diode recovery times







## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

### 4.1 IPAK (TO-251) type A package information

Figure 21: IPAK (TO-251) type A package outline *L2* D b2 (3x) Н **b** (3x) A 1 *B5* 0068771\_IK\_typeA\_rev14 e 1-

Table 8: IPAK (TO-251) type A package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.30	
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
Е	6.40		6.60
е		2.28	
e1	4.40		4.60
Н		16.10	
L	9.00		9.40
L1	0.80		1.20
L2		0.80	1.00
V1		10°	

## 4.2 IPAK (TO-251) type C package information

Figure 22: IPAK (TO-251) type C package outline

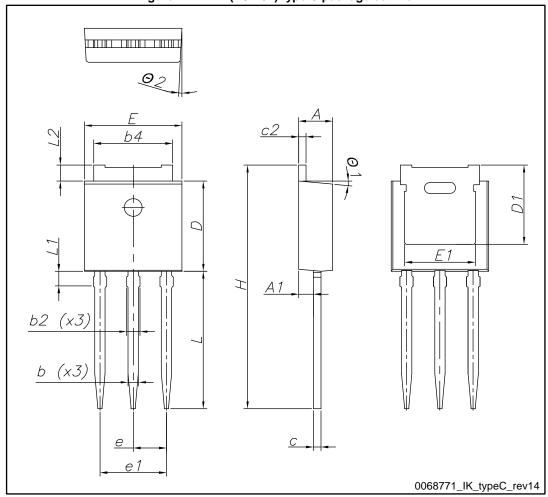


Table 9: IPAK (TO-251) type C package mechanical data

	145.6 0. 11 741 (10 201) typ	mm	
Dim.	Min.	Тур.	Max.
А	2.20	2.30	2.35
A1	0.90	1.00	1.10
b	0.66		0.79
b2			0.90
b4	5.23	5.33	5.43
С	0.46		0.59
c2	0.46		0.59
D	6.00	6.10	6.20
D1	5.20	5.37	5.55
E	6.50	6.60	6.70
E1	4.60	4.78	4.95
е	2.20	2.25	2.30
e1	4.40	4.50	4.60
Н	16.18	16.48	16.78
L	9.00	9.30	9.60
L1	0.90	1.00	1.20
L2	0.90	1.08	1.25
θ1	3°	5°	7°
θ2	1°	3°	5°

Revision history STD1NK60-1

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
09-Feb-2017	1	First release.

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